

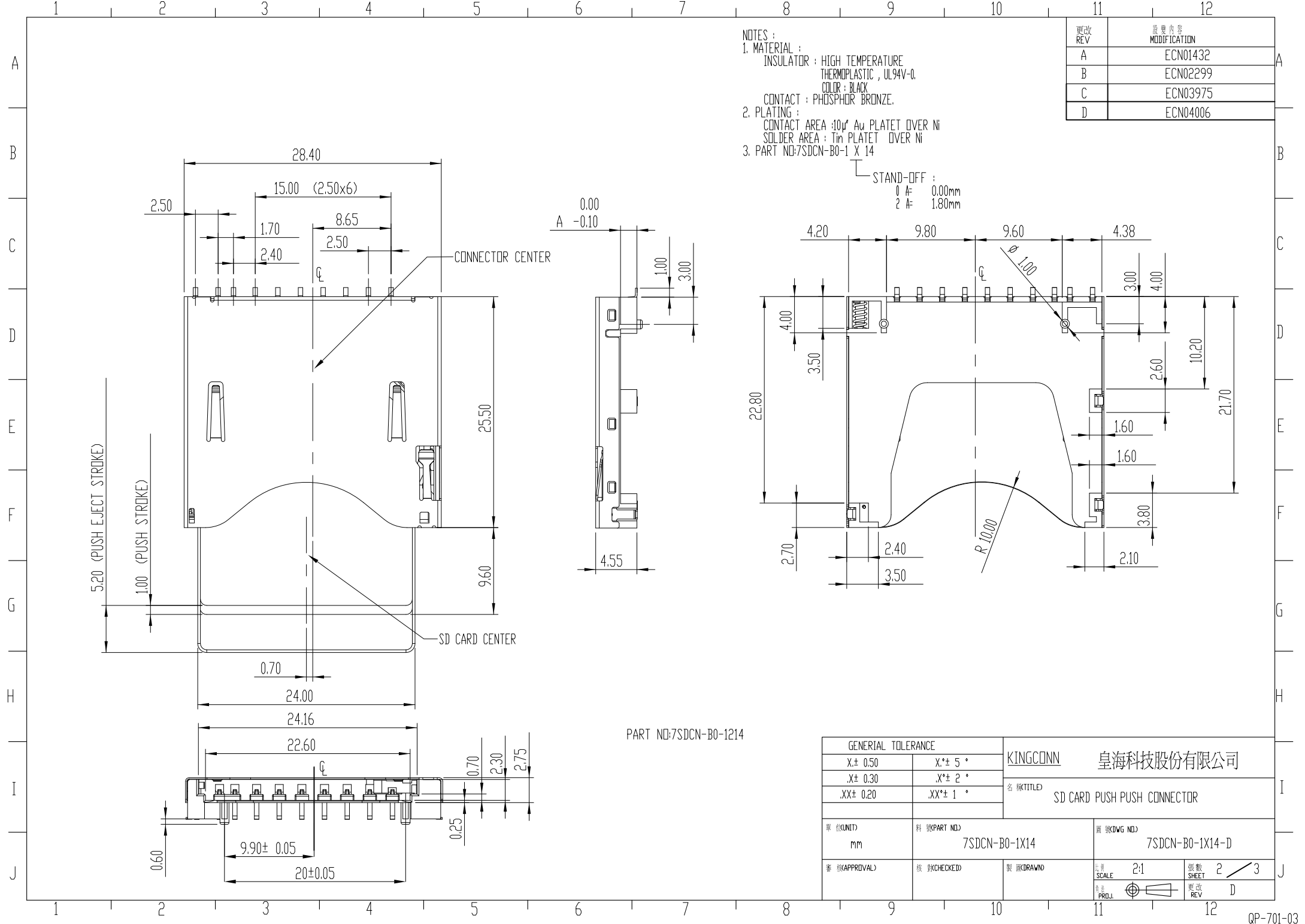
NOTES :
 1. MATERIAL :
 INSULATOR : HIGH TEMPERATURE THERMOPLASTIC , UL94V-0.
 COLOR : BLACK
 CONTACT : PHOSPHOR BRONZE.
 2. PLATING :
 CONTACT AREA :10μ Au PLATET OVER Ni
 SOLDER AREA : Tin PLATET OVER Ni
 3. PART NO:7SDCN-B0-1 X 14

更改 REV	變更內容 MODIFICATION
A	ECN01432
B	ECN02299
C	ECN03975
D	ECN04006

STAND-OFF :
 0 A= 0.00mm
 2 A= 1.80mm

PART NO: 7SDCN-B0-1014

GENERAL TOLERANCE		KINGCONN 皇海科技股份有限公司	
X± 0.50	X*± 5 °	名稱(TITLE) SD CARD PUSH PUSH CONNECTOR	
.X± 0.25	.X*± 2 °		
.XX± 0.15	.XX*± 1 °		
單位(UNIT) mm	料號(PART NO) 7SDCN-B0-1X14	圖號(DWG NO) 7SDCN-B0-1X14	
審核(APPROVAL)	核對(CHECKED)	製圖(DRAWN)	比例(SCALE) 2:1
			張數(SHEET) 1/1
			更改 REV D



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 - PART NO:7SDCN-B0-1 X 14

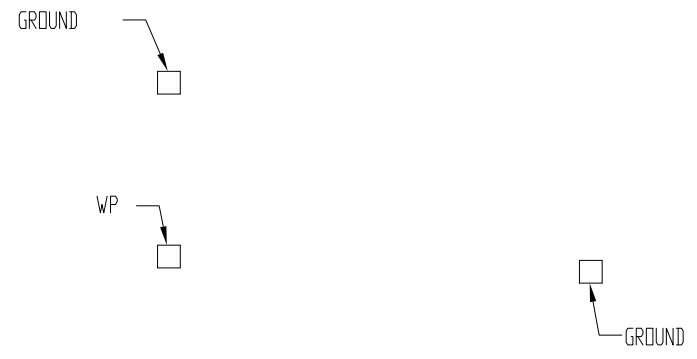
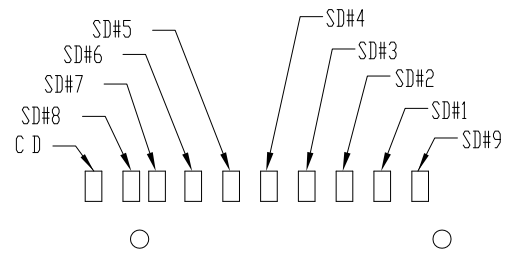
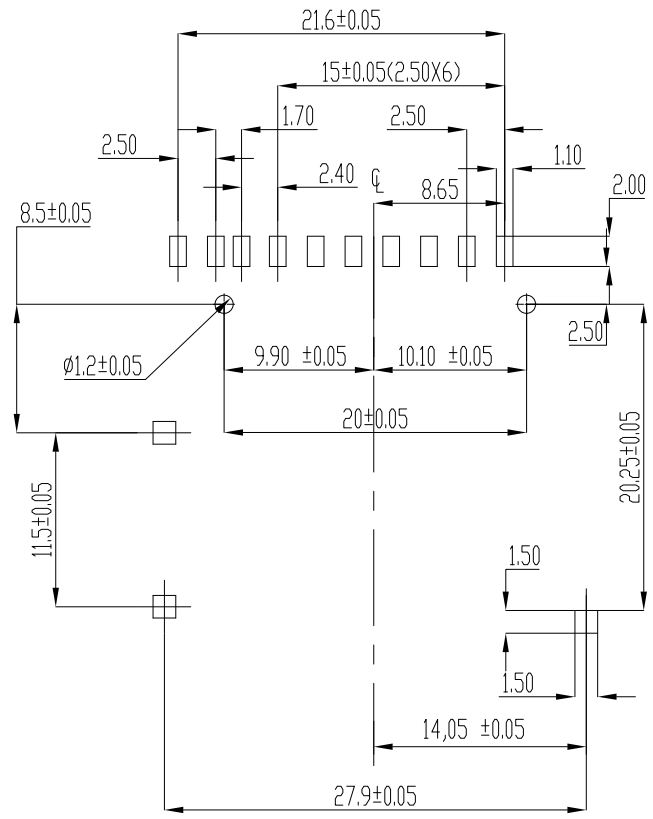
STAND-OFF :
0 A= 0.00mm
2 A= 1.80mm

更改 REV	變更內容 MODIFICATION
A	ECN01432
B	ECN02299
C	ECN03975
D	ECN04006

PART NO:7SDCN-B0-1214

GENERAL TOLERANCE		KINGCONN 皇海科技股份有限公司	
X± 0.50	X*± 5°	名稱(TITLE) SD CARD PUSH PUSH CONNECTOR	
X± 0.30	X*± 2°		
.XX± 0.20	.XX*± 1°		
單位(UNIT) mm	料號(PART NO.) 7SDCN-B0-1X14	圖號(DWG NO.) 7SDCN-B0-1X14-D	
審核(APPROVAL)	核對(CHECKED)	製圖(DRAWN)	比例 SCALE 2:1 張數 SHEET 2 / 3 更改 REV D

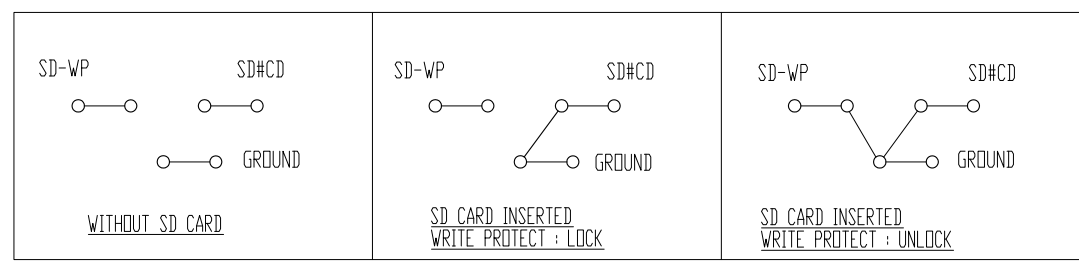
更改 REV	設變內容 MODIFICATION
A	ECN01432
B	ECN02299
C	ECN03975
D	ECN04006



PIN NO.	PIN DEF.
SD#1	SD- DAT3
SD#2	CMD
SD#3	VSS
SD#4	VDD
SD#5	CLK
SD#6	VSS
SD#7	DAT0
SD#8	DAT1
SD#9	DAT2
SD#CD	SD- CD

PCB LAYOUT
(ALL TOLERANCE ARE ±0.05)

SD CIRCUIT :



GENERAL TOLERANCE		KINGCONN 皇海科技股份有限公司	
X± 0.50	X*± 5°	名稱(TITLE) SDCARD PUSH PUSH CONNECTOR	
.X± 0.30	.X*± 2°		
.XX± 0.20	.XX*± 1°		
單位(UNIT) mm	料號(PART NO.) 7SDCN-B0-1X14	圖號(DWG NO.) 7SDCN-B0-1X14-D	比例 SCALE 2:1
審核(APPROVAL)	核對(CHECKED)	製圖(DRAWN)	張數 SHEET 3 / 3
			更改 REV D